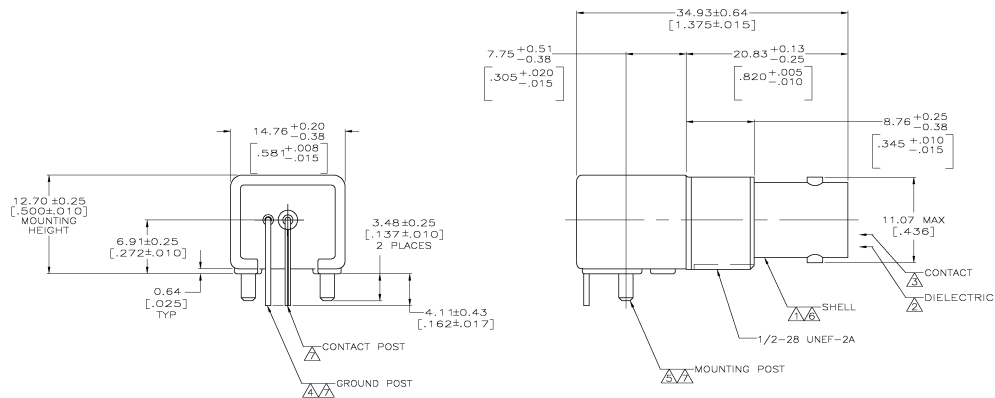
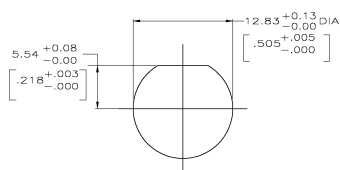


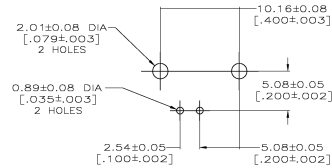
|     |      |           |    |                     |         |    |     |
|-----|------|-----------|----|---------------------|---------|----|-----|
| LOC | DATE | REVISIONS |    |                     |         |    |     |
| AJ  | 16   | #         | UN | DESCRIPTION         | DATE    | BY | APP |
|     |      | B         |    | PER EC 0514-0184-04 | 12-8-04 | KW | JL  |



-  ZINC PER QQ-Z-363.  
 POLYMETHYLPENTENE PER ASTM-D-1238.  
 PHOSPHOR BRONZE PER QQ-B-750.  
 BRASS PER ASTM-B-453.  
 BRASS PER ASTM-B-16.  
 NICKEL PLATE PER QQ-N-290,  
3.81 µm [.000150] MINIMUM THICK.  
 TIN PLATE PER ASTM-B-545,  
3.81 µm [.000150] MINIMUM THICK.  
 GOLD PLATE PER MIL-G-45204,  
1.27 µm [.000050] MINIMUM THICK.  
 GOLD PLATE PER MIL-G-45204,  
0.76 µm [.000030] MINIMUM THICK.



RECOMMENDED PANEL CUTOUT



PCB CONFIGURATION

|                                                                                       |             |
|---------------------------------------------------------------------------------------|-------------|
|  | 413879-2    |
|  | 413879-1    |
| CONTACT<br>FINISH                                                                     | PART NUMBER |

[illegible]